



Mini-Circuits

IMPEDANCE MATCHING

Power Splitter/Combiner **SBTC-2-10-7550+**

2 Way-0° 50/75Ω 5 to 1000 MHz

FEATURES

- 75Ω Input, 50Ω Output
- Excellent Isolation, 24 dB Typ.
- Very Good Phase Unbalance, 1.0 deg. Typ.
- Small Size, 0.15x0.15x0.15"
- Temperature Stable LTCC Base
- Small Size
- Low Cost
- Aqueous Washable
- Protected by US Patent 6,963,255



Generic photo used for illustration purposes only

CASE STYLE: AT790

+RoHS CompliantThe +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Impedance Matching
- Balanced Amplifiers

ELECTRICAL SPECIFICATIONS AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		5		1000	MHz
Insertion Loss Above 3.0 dB	5-50		0.5	1.3	dB
	50-500		0.6	1.1	
	500-1000		0.7	1.5	
Isolation	5-50	13	23		dB
	50-500	20	24		
	500-1000	20	26		
Phase Unbalance	5-50			6	Degree
	50-500			3	
	500-1000			5	
Amplitude Unbalance	5-50			0.8	dB
	50-500			0.5	
	500-1000			0.5	

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +100°C
Power Input (as a Splitter)	0.5 W max.
Internal Dissipation	0.125 W max

Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



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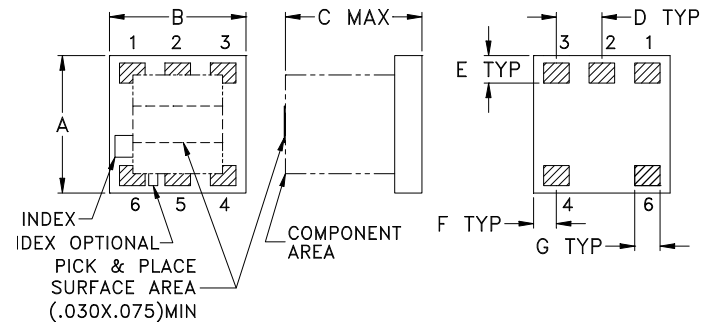
Power Splitter/Combiner **SBTC-2-10-7550+**

2 Way-0° 50/75Ω 5 to 1000 MHz

PIN CONNECTIONS

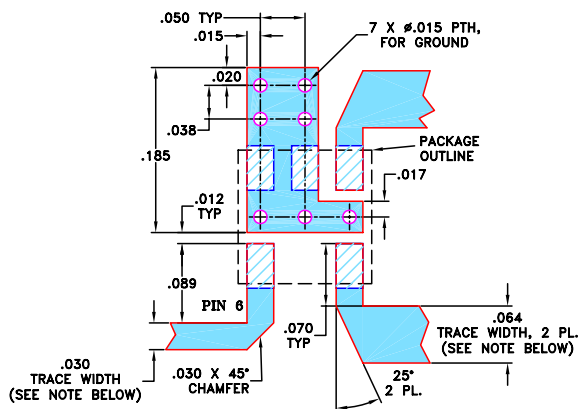
SUM PORT	6 (75Ω)
PORT 1	3 (50Ω)
PORT 2	4 (50Ω)
GROUND	1,2
NOT USED	5

OUTLINE DRAWING



PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-147
SUGGESTED PCB LAYOUT (PL-092)

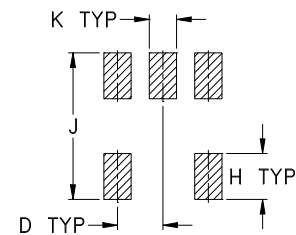


NOTE: TRACE WIDTH IS SHOWN FOR ROGERS RO4350 WITH DIELECTRIC THICKNESS $0.030" \pm 0.002"$, COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

DENOTES PCB COPPER LAYOUT

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

PCB Land Pattern



Suggested Layout,
Tolerance to be within ± 0.002

OUTLINE DIMENSIONS (Inches mm)

A	B	C	D	E	F	G	H	J	K	wt
.150	.150	.150	.050	.030	.025	.028	.050	.160	.030	grams
3.81	3.81	3.81	1.27	0.76	0.64	0.71	1.27	4.06	0.76	0.10

TAPE & REEL INFORMATION: F15



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IMPEDANCE MATCHING

Power Splitter/Combiner

SBTC-2-10-7550+

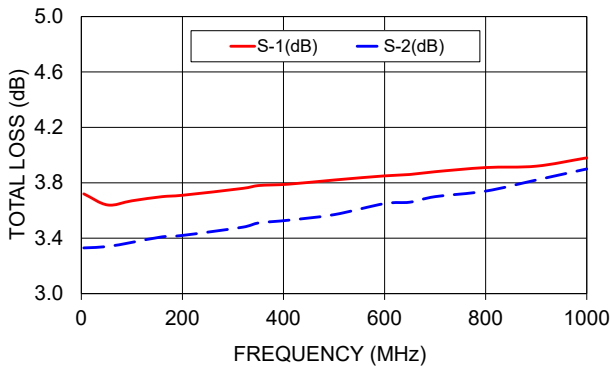
2 Way-0° 50/75Ω 5 to 1000 MHz

TYPICAL PERFORMANCE DATA

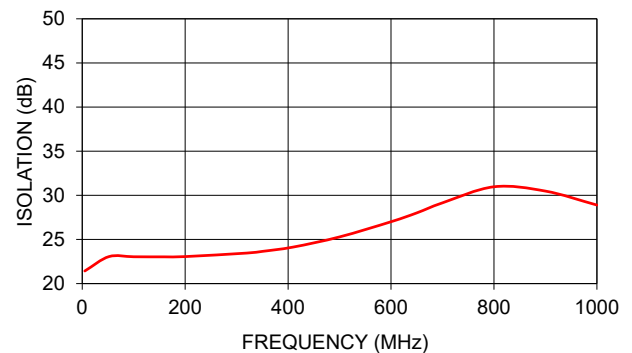
Frequency (MHz)	Total Loss ¹ (dB)		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	VSWR (:1)		
	S-1	S-2				S	1	2
5.00	3.72	3.33	0.39	21.43	1.97	1.19	1.29	1.17
52.00	3.64	3.34	0.29	23.06	0.18	1.15	1.18	1.11
100.00	3.67	3.37	0.30	23.04	0.08	1.15	1.17	1.11
160.00	3.70	3.41	0.29	23.03	0.35	1.14	1.17	1.11
200.00	3.71	3.42	0.28	23.06	0.43	1.15	1.17	1.12
320.00	3.76	3.48	0.28	23.46	0.73	1.17	1.18	1.16
350.00	3.78	3.51	0.27	23.65	0.72	1.18	1.18	1.17
410.00	3.79	3.53	0.26	24.14	0.91	1.20	1.18	1.19
500.00	3.82	3.57	0.25	25.29	1.00	1.23	1.19	1.22
600.00	3.85	3.65	0.20	27.01	1.12	1.27	1.20	1.25
650.00	3.86	3.66	0.20	28.01	1.15	1.29	1.20	1.26
700.00	3.88	3.70	0.18	29.15	1.15	1.31	1.20	1.27
800.00	3.91	3.74	0.17	30.97	1.23	1.37	1.21	1.29
900.00	3.92	3.82	0.11	30.48	1.25	1.39	1.23	1.31
1000.00	3.98	3.90	0.07	28.90	1.23	1.38	1.27	1.35

1. Total Loss = Insertion Loss + 3 dB splitter loss.

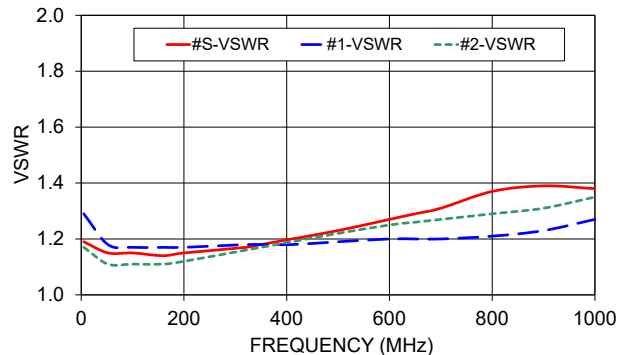
TOTAL LOSS



ISOLATION



VSWR



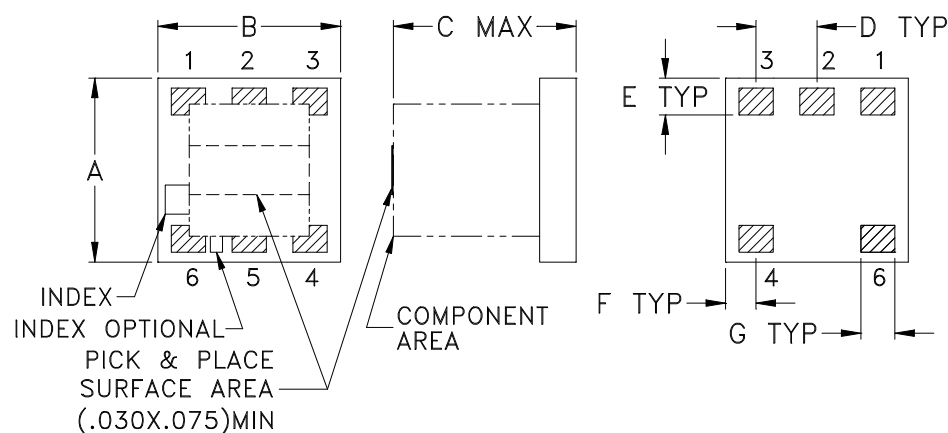
NOTES

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

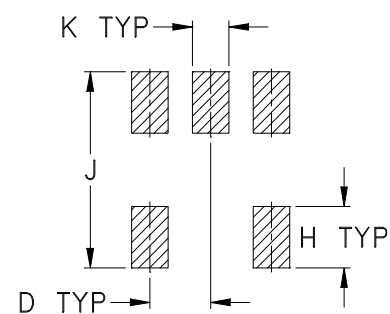


Outline Dimensions

AT790



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT790	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.050 (1.27)	.160 (4.06)	.030 (0.76)	-- --	.10

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

1. Open style, Ceramic base.
2. Termination finish: Silver palladium or gold over nickel based on stock availability.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

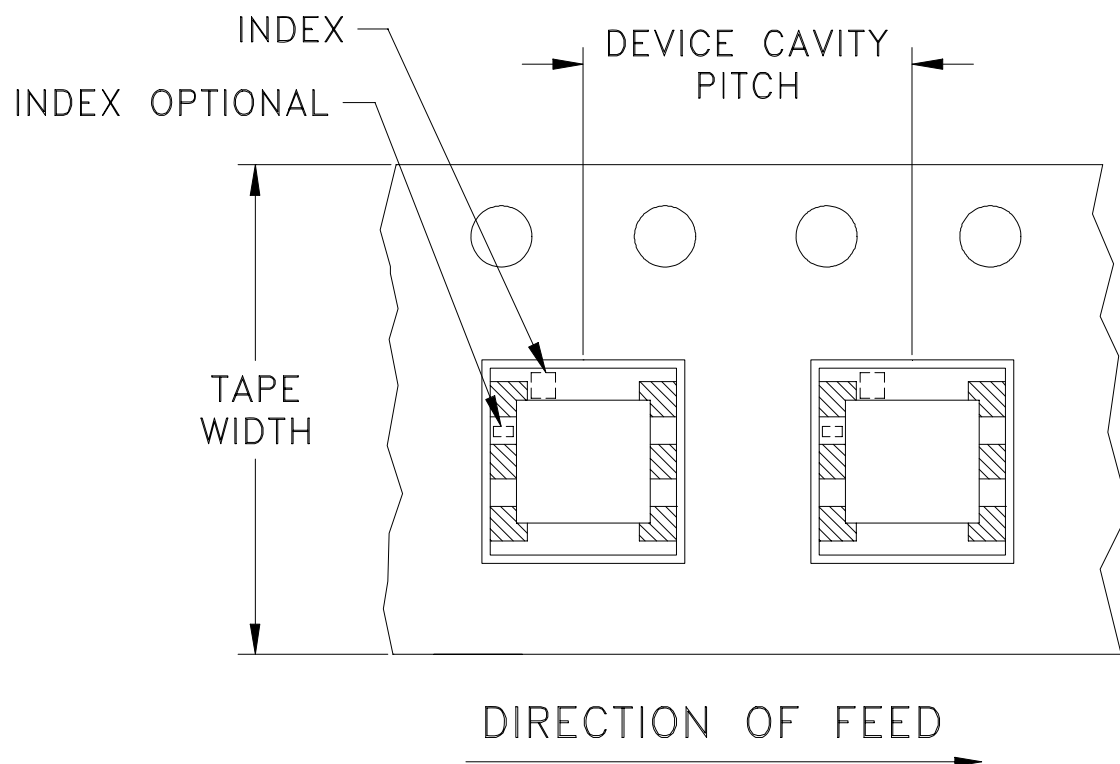


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F15

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
12	8	7	20
			50
			100
			200
		13	500
			1000
			2000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



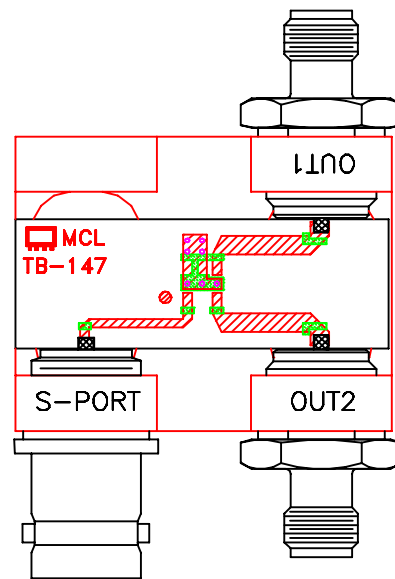
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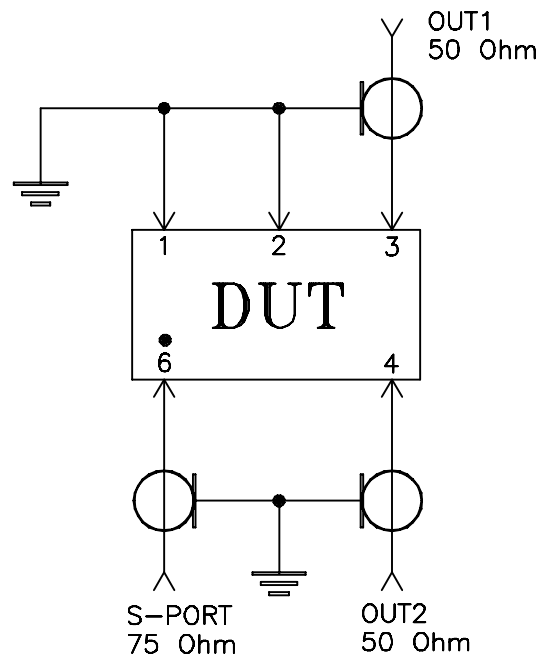
INTERNET <http://www.minicircuits.com>

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

Evaluation Board and Circuit



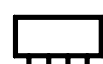
TB-147



Schematic Diagram

Notes:

1. 75 Ohm BNC AND 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215